

Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: Utility
Suggested Classification::
Suggested Group Art Unit::
CD-ROM or CD-R?:: None
Number of CD disks::
Number of Copies of CDs::
Sequence Submission?:: None
Computer Readable Form (CRF):: No
Number of copies of CRF:: 0
Title:: FABRICATION METHOD FOR A
SEMICONDUCTOR CSP TYPE PACKAGE
Attorney Docket Number:: 8008-1045
Request for Early
Publication?:: No
Request for Non-Publication?:: No
Suggested Drawing Figure::
Total Drawing Sheets:: 23
Small Entity?:: No
Latin Name::
Variety Denomination Name::
Petition Included?:: No
Petition Type::
Licensed US Gov't Agency::
Contract or Grant Numbers::
Secrecy Order in Parent No
Appl.?::

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: JAPAN
Status:: Full Capacity
Given Name:: MASANAO
Middle Name::
Family Name:: HORIE
City of Residence:: KANAGAWA
State or Province of Residence::
Country of Residence:: JAPAN
Street of Mailing Address:: 1753 SHIMONUMABE
Address:: NAKAHARA-KU, KAWASAKI
City of Mailing Address:: KANAGAWA
State or Province of Mailing Address::
Country of Mailing Address:: JAPAN
Postal or Zip Code of Mailing Address:: 211-8668

Correspondence Information

Correspondence Customer Number:: 000466
Number::

Representative Information

Representative Customer Number::	000466
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Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2002-236640	8/14/02	Yes

Assignment Information

Assignee Name:: NEC ELECTRONICS CORPORATION
Street of Mailing Address:: 1753 SHIMONUMABE
Address:: NAKAHARA-KU, KAWASAKI
City of Mailing Address:: KANAGAWA
State or Province of Mailing Address::
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